

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of	:	Customer Number: 89518
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Mou-Shiung Lin, et al.	:	Confirmation Number: 6103
	:	
Application No.: 10/055,560	:	Group Art Unit: 2813
	:	
Filed: January 22, 2002	:	Examiner: JAMES M. MITCHELL
	:	
For: INTEGRATED CHIP PACKAGE STRUCTURE USING METAL SUBSTRATE AND METHOD OF MANUFACTURING THE SAME	:	

**INFORMATION DISCLOSURE STATEMENT**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**CERTIFICATE OF ELECTRONIC TRANSMISSION**

I hereby certify that this correspondence is being electronically-transmitted to the United States Patent and Trademark Office on January 24, 2011,  
/Patricia A. Balero/  
Patricia A. Balero

Dear Sir:

In accordance with the provisions of 37 C.F.R. 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the documents listed on the attached form PTO-1449. It is respectfully requested that the documents be expressly considered during the prosecution of this application, and that the documents be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

Out of an abundance of caution and in keeping with Applicants' obligation to bring possibly relevant material to the attention of the examiner in this pending application, Applicants cite the references in this IDS for the examiner's consideration.

This Information Disclosure Statement is being filed after a Request For Continued Examination AND before the mailing date of a first Office Action on the merits. No certification or fee is required.

**10/055,560**

Please charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account 502624 and please credit any excess fees to such deposit account.

Respectfully submitted,

McDERMOTT WILL & EMERY LLP

/Dennis A. Duchene/  
Dennis A. Duchene  
Registration No. 40,595

11682 El Camino Real, Suite 400  
San Diego, CA 92130  
Phone: 858.720.3300 DAD:pab  
Facsimile: 858.720.7800  
**Date: January 21, 2011**

**Please recognize our Customer No. 89518  
as our correspondence address.**